# LNJ406K5YRX

Surface Mounting Chip LED

S-J Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

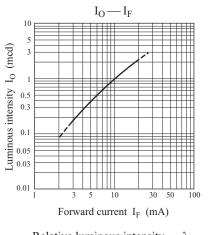
Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	60	mW	
Forward current	$I_{\rm F}$	20	mA	
Pulse forward current *	I <sub>FP</sub>	60	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

Lighting Color

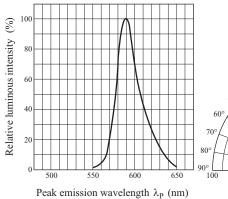
Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

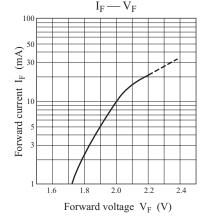
#### Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>	$I_{\rm F} = 10 \text{ mA}$	0.4	1.0		mcd
Reverse current	I <sub>R</sub>	$V_R = 4 V$			10	μΑ
Forward voltage	V <sub>F</sub>	$I_{\rm F} = 10 \text{ mA}$		2.0	2.6	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_{\rm F} = 10 \text{ mA}$		590		nm
Spectral half band width	Δλ	$I_{\rm F} = 10 \text{ mA}$		30		nm









Directive characteristics

0 10

20

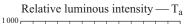
10

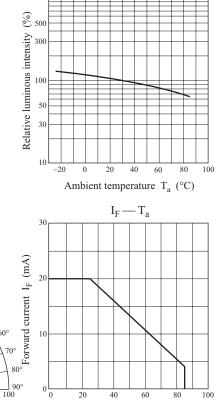
20

70

80

60





Ambient temperature T<sub>a</sub> (°C)

Relative luminous intensity (%)

Publication date: December 2008

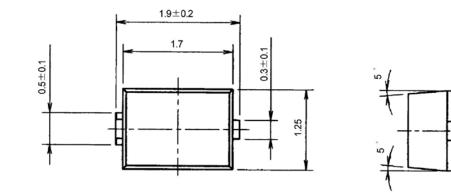
<sup>•</sup> Amber

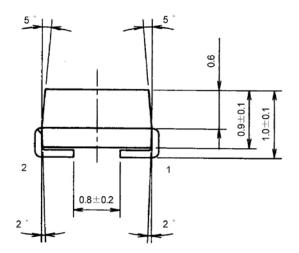
#### LNJ406K5YRX

### **Panasonic**

Package (Unit: mm)

### LLTFTN2J0600





• Pin name

1: Anode

2: Cathode

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